

## Features

- ESD Protection for 1 line with Bi-directional
- Provide ESD protection for the protected line to  
**IEC 61000-4-2 (ESD)  $\pm 30\text{kV}$  (air),  $\pm 30\text{kV}$  (contact)**  
**IEC 61000-4-4 (EFT) 80A (5/50ns)**  
**IEC 61000-4-5 (Lightning) 20A (8/20 $\mu\text{s}$ )**
- **For low operating voltage applications: 2.5V**
- **0402 small DFN package** saves board space
- Protect one I/O line or power line
- Fast turn-on and Low clamping voltage
- Solid-state silicon-avalanche and active circuit triggering technology
- **Green Part**

## Applications

- Mobile Phones
- Hand Held Portable Applications
- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Ports Protection
- Control Signal Lines Protection
- Power lines on PCB Protection
- Latchup Protection

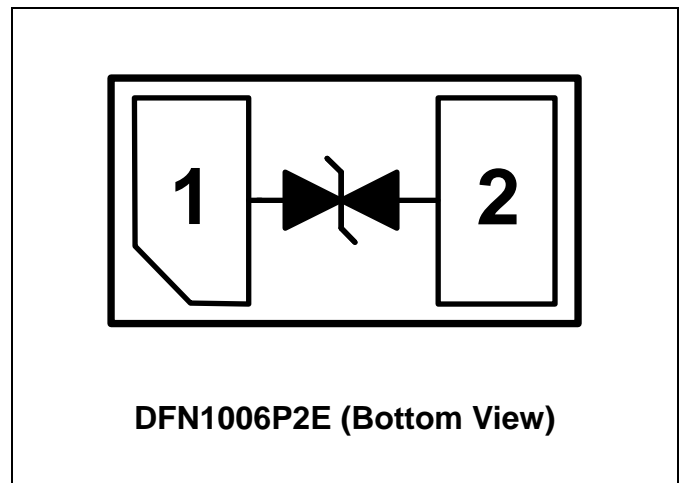
## Description

AZ6225-01F is a design which includes one bi-directional surge rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic systems. The AZ6225-01F has been specifically designed to protect sensitive components which are connected to power and control lines from over-voltage damage and latch-up caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

AZ6225-01F is a unique design which includes proprietary clamping cell in a single package. During transient conditions, the proprietary clamping cell prevents over-voltage on the power line or control/data lines, protecting any downstream components.

AZ6225-01F may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ( $\pm 15\text{kV}$  air,  $\pm 8\text{kV}$  contact discharge).

## Circuit Diagram / Pin Configuration





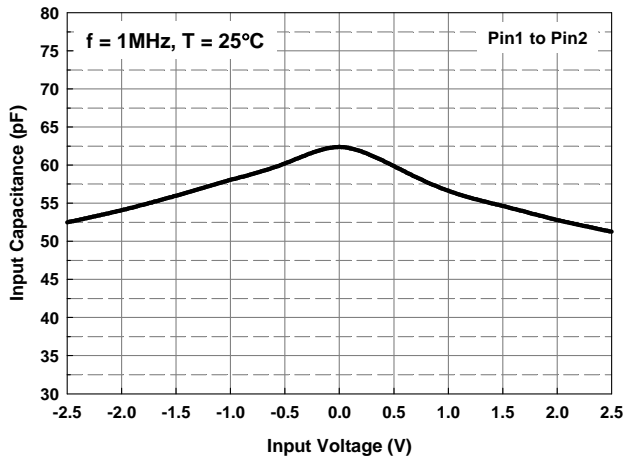
## SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	SYMBOL	RATING	UNITS
Peak Pulse Current (tp=8/20μs)	I <sub>PP</sub>	20	A
Operating Supply Voltage (pin-1 to pin-2)	V <sub>DC</sub>	2.8	V
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Lead Soldering Temperature	T <sub>SOL</sub>	260 (10 sec.)	°C
Operating Temperature	T <sub>OP</sub>	-55 to +85	°C
Storage Temperature	T <sub>STO</sub>	-55 to +150	°C

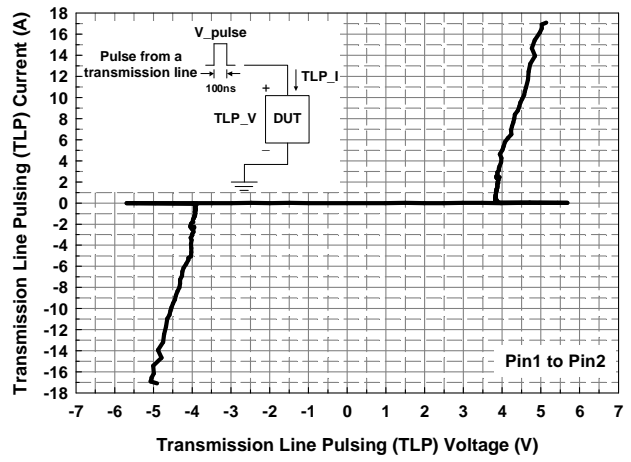
ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V <sub>RWM</sub>	T=25 °C.	-2.5		2.5	V
Reverse Leakage Current	I <sub>Leak</sub>	V <sub>RWM</sub> = ±2.5V, T=25 °C.			2	μA
Reverse Breakdown Voltage	V <sub>BV</sub>	I <sub>BV</sub> = 1mA, T=25 °C.	3.5			V
Surge Clamping Voltage	V <sub>surge.CL</sub>	I <sub>PP</sub> =5A, tp=8/20μs, T=25 °C.		4.0		V
		I <sub>PP</sub> =10A, tp=8/20μs, T=25 °C.		5.0		
		I <sub>PP</sub> =20A, tp=8/20μs, T=25 °C.		6.8		
ESD Clamping Voltage	V <sub>clamp</sub>	IEC 61000-4-2 +6kV, Contact mode, T=25 °C, I/O pin to GND		5.0		V
ESD Dynamic Turn-on Resistance	R <sub>dynamic</sub>	IEC 61000-4-2 0~+6kV, Contact mode, T=25 °C.		0.07		Ω
Channel Input Capacitance	C <sub>IN</sub>	V <sub>R</sub> = 0V, f = 1MHz, T=25 °C.		62.5	80	pF

## Typical Characteristics

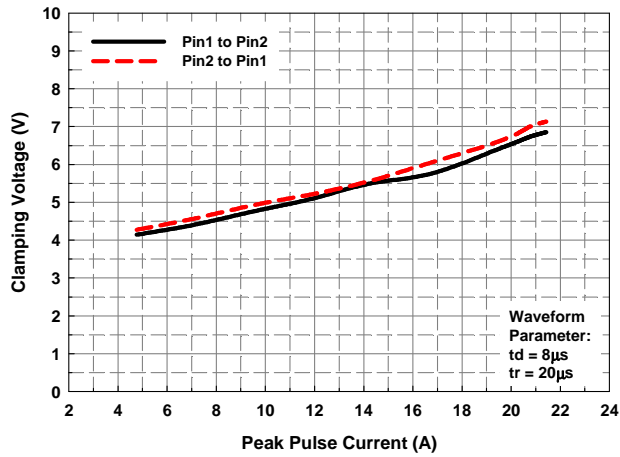
Typical Variation of  $C_{IN}$  vs.  $V_{IN}$



Transmission Line Pulsing (TLP) Measurement



Clamping Voltage vs. Peak Pulse Current



## Applications Information

The AZ6225-01F is designed to protect one line against System ESD/EFT/Lightning pulses by clamping it to an acceptable reference. It provides bi-directional protection.

The usage of the AZ6225-01F is shown in Fig. 1. Protected line, such as data line, control line, or power line, is connected at pin 1. The pin 2 is connected to a ground plane on the board. In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ6225-01F should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ6225-01F.
- Place the AZ6225-01F near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

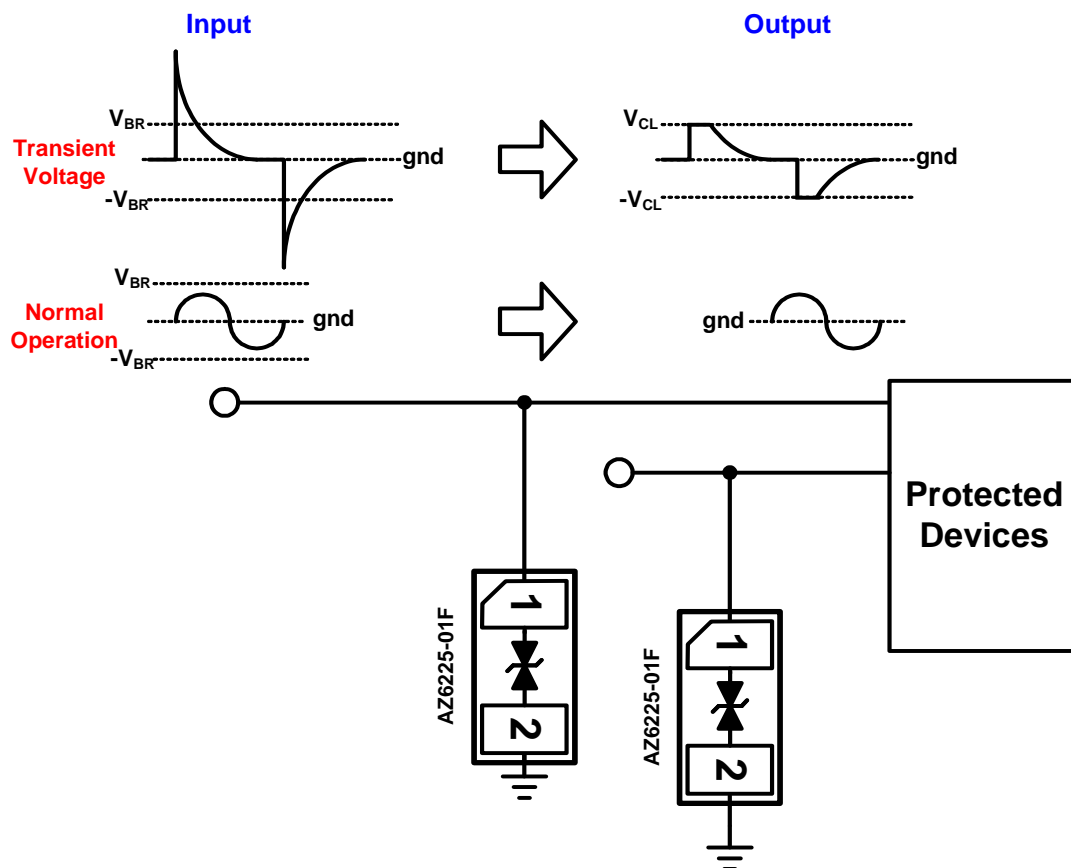


Fig. 1



Fig. 2 shows another simplified example of using AZ6225-01F to protect the control line, low speed data line, and power line from ESD transient stress.

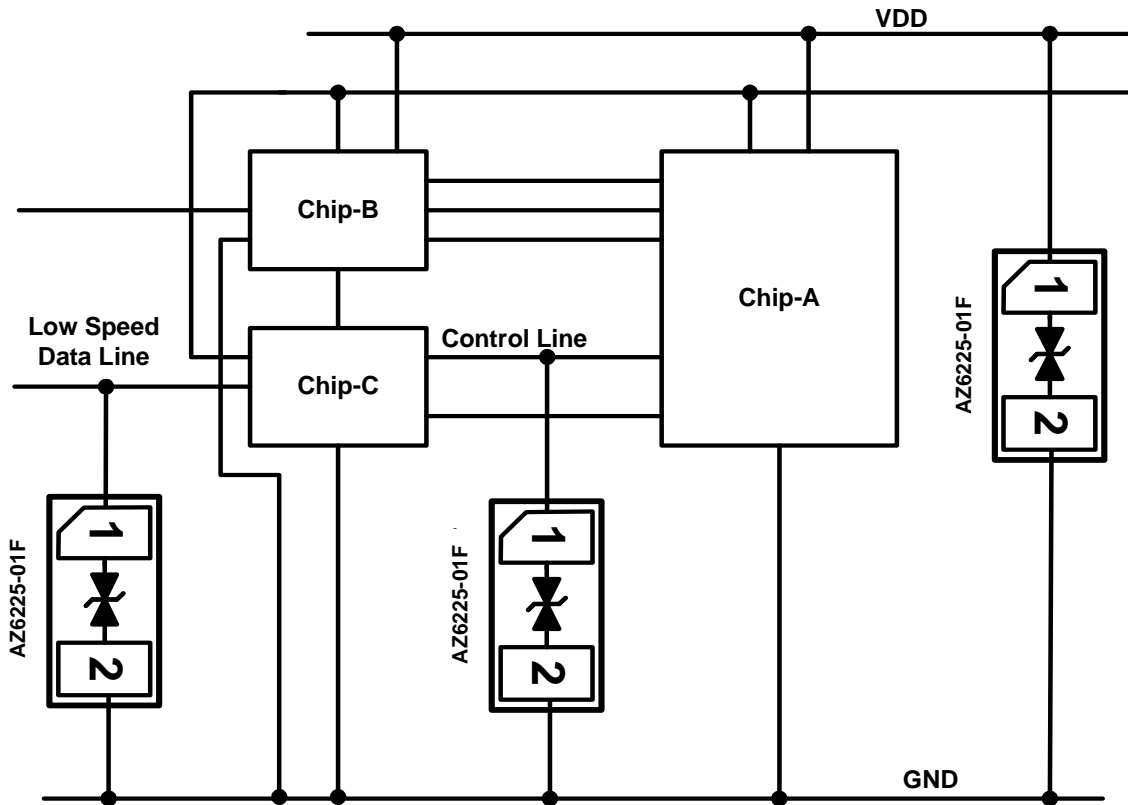
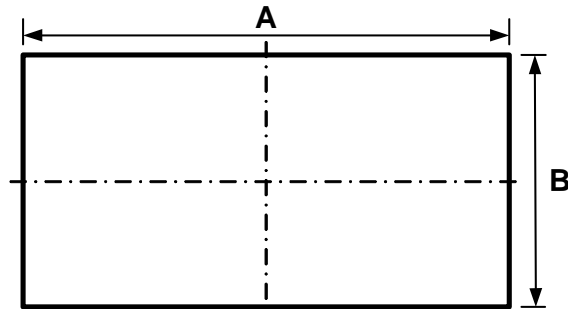


Fig. 2

## Mechanical Details

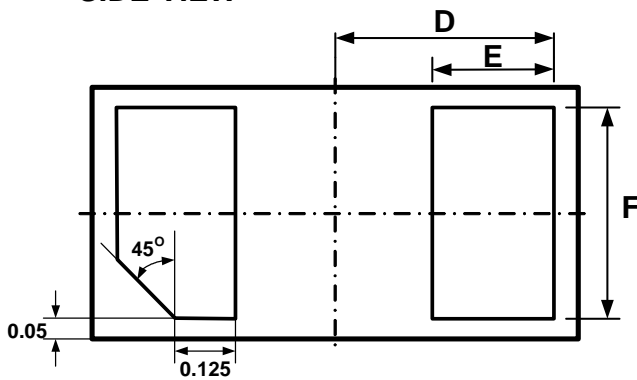
### DFN1006P2E PACKAGE DIAGRAMS



TOP VIEW



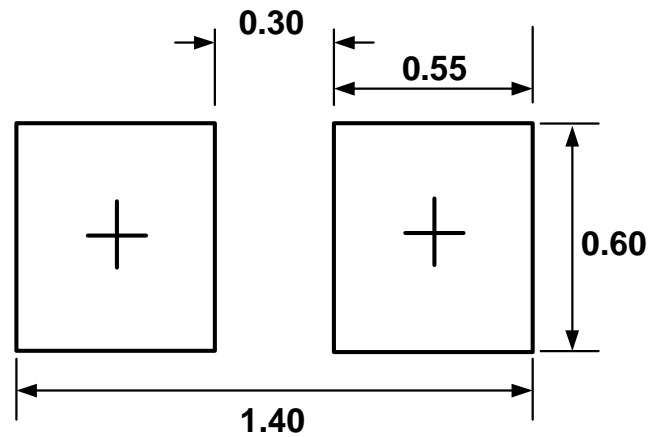
SIDE VIEW



BOTTOM VIEW

Symbol	Millimeters		Inches	
	min	max	min	max
A	0.95	1.05	0.037	0.041
B	0.55	0.65	0.022	0.026
C	0.45	0.60	0.018	0.024
D	0.45		0.018	
E	0.20	0.30	0.008	0.012
F	0.45	0.55	0.018	0.022

## LAND LAYOUT

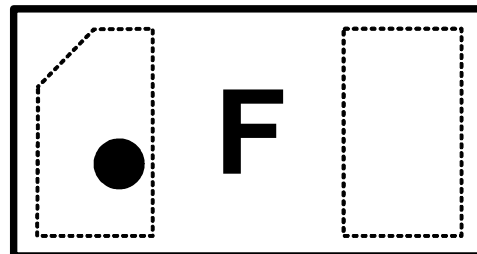


(Unit: mm)

### Notes:

This LAND LAYOUT is for reference purposes only. Please consult your manufacturing partners to ensure your company's PCB design guidelines are met.

## MARKING CODE



Top View

Part Number	Marking Code
AZ6225-01F (Green Part)	F

Note : Green means Pb-free, RoHS, and Halogen free compliant.



### Ordering Information

PN#	Material	Type	Reel size	MOQ	MOQ/internal box	MOQ/carton
AZ6225-01F.R7GR	Green	T/R	7 inch	12,000/reel	4 reel=48,000/box	6 box=288,000/carton

### Revision History

Revision	Modification Description
Revision 2014/02/20	Preliminary Release.
Revision 2014/12/03	Formal Release.